# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
Guichea Na	01/30/2007
Soohan Park	01/30/2007
Gwangjin Kim	01/30/2007

### **RECEIVING PARTY DATA**

Name:	STATS ChipPAC Ltd.
Street Address:	5 Yishun Street 23
City:	Singapore
State/Country:	SINGAPORE
Postal Code:	768442

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11673558

#### **CORRESPONDENCE DATA**

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Correspondent Name: Mikio Ishimaru

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ATTORNEY DOCKET NUMBER: 27-316

NAME OF SUBMITTER: Mikio Ishimaru

Total Attachments: 2

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## ASSIGNMENT

WHEREAS, the undersigned (hereinafter termed Assignor(s)) has/have invented certain new and useful improvements in

## INTEGRATED CIRCUIT PACKAGE SYSTEM WITH BUMP OVER VIA

for which a United States patent application has been executed on or before the date of this assignment;

WHEREAS, STATS ChipPAC Ltd., a Corporation of the Republic of Singapore, having a place of business at 5 Yishun Street 23, Singapore 768442 (hereinafter termed Assignee), is desirous of acquiring the entire right, title and interest in and to said application and said invention and improvements thereon, and in and to Letters Patents thereon when granted in the United States and foreign countries;

NOW, THEREFORE, for good and valuable consideration received by said Assignor(s) from said Assignee, the receipt of which is hereby acknowledged by said Assignor(s):

- Said Assignor(s) does hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest in and to said application and said invention and in and to any and all improvements on said invention and in and to any and all improvements on said invention heretofore or hereafter made or acquired by said Assignor(s); and in and to any and all Letters Patent on said invention and/or said improvements that may be granted in the United States or any foreign country, including each and every Letters Patent granted on any application which is a division, continuation, substitution, renewal, or continuation-in-part of any said application, and in and to each and every reissue or extension of said Letters Patent.
- 2. Said Assignor(s) hereby covenants and agrees to cooperate with said Assignee where said Assignee may enjoy to the fullest extent the right, title and interest herein conveyed. Such cooperation shall include (a) prompt execution of all papers (prepared at the expense of Assignee) which are deemed necessary or desirable by Assignee to perfect in it the right, title and interest herein conveyed, (b) prompt execution of all petitions, oaths, specifications or other papers (prepared at the expense of Assignee) which are deemed necessary or desirable by assignee for prosecuting said application, for filing and prosecuting divisional, continuation, substitution, renewal, continuation-in-part, or additional applications in the United States and/or foreign countries covering said invention and/or said improvements, for filing and prosecuting applications for reissuance of letters patent included herein, or for interference proceedings involving said invention and/or said improvements and (c) prompt assistance and cooperation in the prosecution of interference proceedings involving said invention and/or said improvements and in the adjudication of said Letters Patent, particularly by the disclosure of facts and the production of evidence relating to said invention and/or said improvements, provided the expenses which may be incurred by said Assignor(s) in lending such assistance and cooperation shall be paid by the Assignee.
- 3. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee, its successors, assigns and/or other legal representatives and shall be binding upon said Assignor(s), his/her heirs, legal representatives and assigns.
- 4. Said Assignor(s) hereby warrants and represents that he/she has not entered into any assignment, contract or understanding in conflict herewith.

PATENT

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

Colno	Jan. 30. 2 00 7
Guichea Na	Date
Jong tra	AAAD
Witness Signature	Witness Signature
Jong - Vin Park Print Witness Name	Seone-BO Affair
Print Witness Name	Print Witness Name
30th Jan, 2007	30th Jan. 2007
Date	Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

manifest Donis	30th, Jan 200)
Soohan Park	Date
EDUCTION REPORTED TO THE PROPERTY OF THE PROPE	My
Witness Signature	Witness Signature
Sin Jae, Lee	Woo Jin kin
Print Witness Name	Print Witness Name
20th Jan. 2007	30th. Jan. 2007
Date	Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

Gwangjin Kim

Date

Witness Signature

Hyunkyum Kim

Print Witness Name

30, Jan, 2007

Date

Witness Signature

Date

Date

Date

Date

Date

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